007034 USA P02/DSM/ELK/JW Application No: 10/783,748 Page 2 of 12

IN THE CLAIMS

Please substitute the following listing of claims for the previous listing of claims:

1. (currently amended) A method of cleaning a chamber of an electron beam treatment apparatus, the method comprising:

generating an electron beam that energizes a cleaning gas in the chamber of the electron beam treatment apparatus;

monitoring an electron beam current;

adjusting a pressure of the cleaning gas to maintain the electron beam current at a substantially constant value; and

stopping the flow of cleaning gas when the cleaning gas pressure becomes substantially constant for a predetermined length of time.

- 2-3. (cancelled).
- (original) The method of claim 1 wherein the cleaning gas comprises an oxygen-based gas.
- 5. (original) The method of claim 4 wherein the oxygen-based gas comprises one or more of O₂, ozone, NO₁ and H₂O.
- 6. (original) The method of claim 1 wherein the cleaning gas comprises a fluorine-based gas.
- 7. (original) The method of claim 6 wherein the fluorine-based gas comprises one or more of NF₃, F₂, CF₄, C₂F₆, C₃F₈, SF₆.

007034 USA P02/DSM/ELK/JW Application No: 10/783,748 Page 3 of 12

8. (Currently amended) A method of cleaning an electron beam treatment chamber, the method comprising:

generating an electron beam that energizes a cleaning gas in a the electron beam treatment chamber; and

stopping the flow of cleaning gas after the cleaning gas pressure becomes substantially constant for a predetermined length of time.

- 9. (original) The method of claim 8 wherein the cleaning gas comprises an oxygen-based gas.
- 10. (original) The method of claim 9 wherein the oxygen-based gas comprises one or more of O₂, ozone, NO, and H₂O.
- 11. (original) The method of claim 8 wherein the cleaning gas comprises a fluorine-based gas.
- 12. (original) The method of claim 11 wherein the fluorine-based gas comprises one or more of NF₃, F₂, CF₄, C₂F₆, C₃F₈, SF₆.
- 13. (original) The method of claim 8 wherein a gas pressure of about1 Torr or greater is maintained in the chamber.
- 14. (original) The method of claim 9 wherein a gas pressure of about1 Torr or greater is maintained in the chamber.
- 15. (original) The method of claim 11 wherein a gas pressure of about1 Torr or greater is maintained in the chamber.

007034 USA P02/DSM/ELK/JW Application No: 10/783,748 Page 4 of 12

16. (currently amended) A method of cleaning a chamber of an electron beam treatment apparatus, the method comprising:

introducing a cleaning gas into the chamber;

generating an electron beam that energizes the cleaning gas in the chamber;

setting in the chamber, an electron beam current of about 10 mA or above:

adjusting a pressure of the cleaning gas to maintain the electron beam current at a substantially constant value; and

determining an endpoint of the cleaning process and stopping introduction of the cleaning gas when the cleaning gas pressure reaches a substantially constant value and maintains the value for a length of time of 5 seconds.

- 17. (previously presented) The method of claim 16 wherein the cleaning gas comprises an oxygen-based gas.
- 18. (previously presented) The method of claim 17 wherein the oxygen-based gas comprises one or more of O_2 , ozone, NO, and H_2O .
- 19. (previously presented) The method of claim 16 wherein the cleaning gas comprises a fluorine-based gas.
- 20. (previously presented) The method of claim 19 wherein the fluorine-based gas comprises one or more of NF₃, F₂, CF₄, C₂F₆, C₃F₈, SF₆.
- 21. (new) The method of claim 1 comprising stopping the flow of cleaning gas when the cleaning gas pressure becomes substantially constant for a length of time of 5 seconds.

007034 USA P02/DSM/ELK/JW Application No: 10/783,748 Page 5 of 12

22. (new) The method of claim 8 comprising stopping the flow of cleaning gas when the cleaning gas pressure becomes substantially constant for a length of time of 5 seconds.